

March 2008

2SA1943/FJL4215 PNP Epitaxial Silicon Transistor

Applications

- · High-Fidelity Audio Output Amplifier
- · General Purpose Power Amplifier

Features

- High Current Capability: I_C = -15A.
- High Power Dissipation: 150watts.
- High Frequency: 30MHz.
- High Voltage: V_{CEO}= -230V
- · Wide S.O.A for reliable operation.
- · Excellent Gain Linearity for low THD.
- Complement to 2SC5200/FJL4315.
- Full thermal and electrical Spice models are available.
- · Same transistor is also available in:
 - -- TO3P package, 2SA1962/FJA4213: 130 watts
 - -- TO220 package, FJP1943: 80 watts
 - -- TO220F package, FJPF1943: 50 watts



1.Base 2.Collector 3.Emitter

Absolute Maximum Ratings* Ta = 25°C unless otherwise noted

| Symbol | Parameter | Ratings | Units | |
|-----------------------------------|--|-------------|-----------|--|
| BV _{CBO} | Collector-Base Voltage | -230 | V | |
| BV _{CEO} | Collector-Emitter Voltage | -230 | V | |
| BV _{EBO} | Emitter-Base Voltage | -5 | ٧ | |
| I _C | Collector Current | -15 | Α | |
| I _B | Base Current | -1.5 | Α | |
| P _D | Total Device Dissipation(T _C =25°C) Derate above 25°C | 150 1.04 | W W/°C | |
| T _J , T _{STG} | Junction and Storage Temperature | - 50 ~ +150 | °C | |

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics* T_a=25°C unless otherwise noted

| Symbol | Parameter | Max. | Units | |
|----------------|--------------------------------------|------|-------|--|
| $R_{	heta JC}$ | Thermal Resistance, Junction to Case | 0.83 | °C/W | |

^{*} Device mounted on minimum pad size

h_{FE} Classification

| Classification | R | 0 |
|------------------|----------|----------|
| h _{FE1} | 55 ~ 110 | 80 ~ 160 |

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$\textbf{Electrical Characteristics*} \ \, \textbf{T}_{a}\text{=-}25^{\circ}\text{C unless otherwise noted}$

| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Units |
|-----------------------|--------------------------------------|--|------|------|------|----------|
| BV _{CBO} | Collector-Base Breakdown Voltage | I _C =-5mA, I _E =0 | -230 | | | V |
| BV _{CEO} | Collector-Emitter Breakdown Voltage | I _C =-10mA, R _{BE} =∞ | -230 | | | V |
| BV _{EBO} | Emitter-Base Breakdown Voltage | I _E =-5mA, I _C =0 | -5 | | | V |
| I _{CBO} | Collector Cut-off Current | V _{CB} =-230V, I _E =0 | | | -5.0 | μΑ |
| I _{EBO} | Emitter Cut-off Current | V _{EB} =-5V, I _C =0 | | | -5.0 | μΑ |
| h _{FE1} | DC Current Gain | V _{CE} =-5V, I _C =-1A | 55 | | 160 | |
| h _{FE2} | DC Current Gain | V _{CE} =-5V, I _C =-7A | 35 | 60 | | |
| V _{CE} (sat) | Collector-Emitter Saturation Voltage | I _C =-8A, I _B =-0.8A | | -0.4 | -3.0 | V |
| V _{BE} (on) | Base-Emitter On Voltage | V _{CE} =-5V, I _C =-7A | | -1.0 | -1.5 | ٧ |
| f _T | Current Gain Bandwidth Product | V _{CE} =-5V, I _C =-1A | | 30 | | MHz |
| C _{ob} | Output Capacitance | V _{CB} =-10V, f=1MHz | | 360 | | pF |

^{*} Pulse Test: Pulse Width=20 μ s, Duty Cycle≤2%

Ordering Information

| Part Number | Marking | Package | Packing Method | Remarks |
|-------------|---------|---------|----------------|--------------|
| 2SA1943RTU | A1943R | TO-264 | TUBE | hFE1 R grade |
| 2SA1943OTU | A1943O | TO-264 | TUBE | hFE1 O grade |
| FJL4215RTU | J4215R | TO-264 | TUBE | hFE1 R grade |
| FJL4215OTU | J4215O | TO-264 | TUBE | hFE1 O grade |

Typical Characteristics

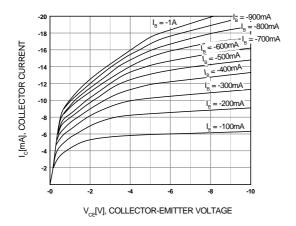


Figure 1. Static Characteristic

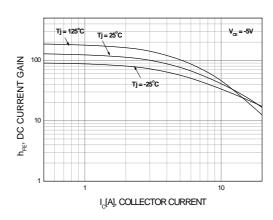


Figure 2. DC current Gain

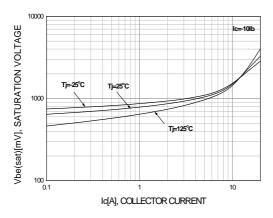


Figure 3. Base-Emitter Saturation Voltage

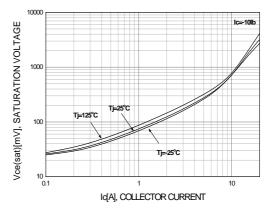


Figure 4. Collector-Emitter Saturation Voltage

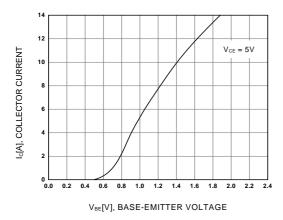


Figure 5. Base-Emitter On Voltage

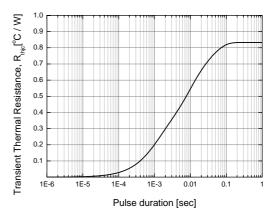


Figure 6. Thermal Resistance

Typical Characteristics

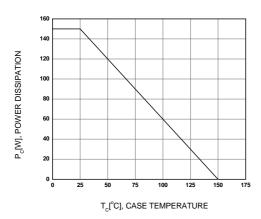


Figure 7. Power Derating

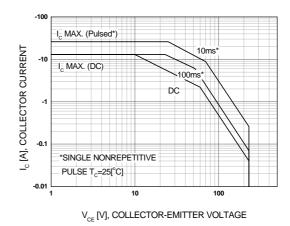
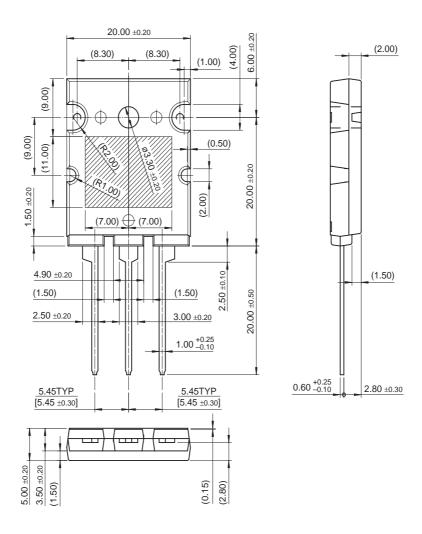


Figure 8. Safe Operating Area

Package Dimensions

TO-264



Dimensions in Millimeters





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|--------------------------|------------------------|--|
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